

# 8-Bit Single Chip Microcontroller

### **Preliminary**

#### Overview

The LC863264/56/48/40A are 8-bit single chip microcontrollers with the following on-chip functional blocks:

- CPU : Operable at a minimum bus cycle time of 0.424µs
- On-chip ROM capacity

Program ROM: 64K/56K/48K/40K bytes

CGROM: 16K bytes

- On-chip RAM capacity: 640 bytes

- OSD RAM:  $352 \times 9$  bits

- Closed-Caption TV controller and the on-screen display controller
- Closed-Caption data slicer
- Four channels × 8-bit AD Converter
- Three channels × 7-bit PWM
- Two 16-bit timer/counters, 14-bit base timer
- 8-bit synchronous serial interface circuit
- IIC-bus compliant serial interface circuit (Multi-master type)
- ROM correction function
- 16-source 10-vectored interrupt system
- Integrated system clock generator and display clock generator

Only one X'tal oscillator (32.768kHz) for PLL reference is used for both generators

TV control and the Closed Caption function

All of the above functions are fabricated on a single chip.

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**Features** 

(1) Read-Only Memory (ROM):  $65024 \times 8 \text{ bits } / 57344 \times 8 \text{ bits } / 49152 \times 8 \text{ bits}$ 

 $40960 \times 8$  bits for program  $16128 \times 8$  bits for CGROM

(2) Random Access Memory (RAM): 640 × 8 bits (including 128 bytes for ROM correction function)

 $352 \times 9$  bits (for CRT display)

(3) OSD functions

- Screen display : 36 characters × 16 lines (by software)

- RAM : 352 words (9 bits per word)

Display area :  $36 \text{ words} \times 8 \text{ lines}$ Control area :  $8 \text{ words} \times 8 \text{ lines}$ 

- Characters

Up to 252 kinds of  $16 \times 32$  dot character fonts

(4 characters including 1 test character are not programmable)

Each font can be divided into two parts and used as two fonts:

a  $16 \times 17$  dot and  $8 \times 9$  dot character font

At least 111 characters need to be divide to display the caption fonts.

- Various character attributes

Character colors : 16 colors
Character background colors : 16 colors
Fringe / shadow colors : 16 colors
Full screen colors : 16colors

Rounding Underline

Italic character (slanting)

- Attribute can be changed without spacing
- Vertical display start line number can be set for each row independently (Rows can be overlapped)
- Horizontal display start position can be set for each row independently
- Horizontal pitch (bit 9 16)\*1 and vertical pitch (bit-32) can be set for each row independently
- Different display modes can be set for each row independently

Caption • Text mode / OSD mode 1 / OSD mode 2 (Quarter size) / Simplifed graphic mode

- Ten character sizes \*1

Horez. 
$$\times$$
 Vert. =  $(1 \times 1)$ ,  $(1 \times 2)$ ,  $(2 \times 2)$ ,  $(2 \times 4)$ ,  $(0.5 \times 0.5)$   
 $(1.5 \times 1)$ ,  $(1.5 \times 2)$ ,  $(3 \times 2)$ ,  $(3 \times 4)$ ,  $(0.75 \times 0.5)$ 

- Shuttering and scrolling on each row
- Simplified Graphic Display
- \*1 Note : range depends on display mode : refer to the manual for details.
- (4) Data Slicer (NTSC)
  - Line 21 closed caption data and XDS data extraction
- (5) Bus Cycle Time / Instruction-Cycle Time

Bus cycle time	Instruction cycle time	System clock oscillation	Oscillation Frequency	Voltage
0.424µs	0.848µs	Internal VCO	14.156MHz	4.5V to 5.5V
		(Ref : X'tal 32.768kHz)		
7.5µs	15.0µs	Internal RC	800kHz	4.5V to 5.5V
183.1µs	366.2µs	Crystal	32.768kHz	4.5V to 5.5V

(6) Ports

Input / Output Ports
 Data direction programmable in nibble units
 1 port (8 terminals)

(If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.)

Data direction programmable for each bit individually : 4 ports (20 terminals)

#### (7) AD converter

- 4 channels × 8-bit AD converters

#### (8) Serial interfaces

- IIC-bus compliant serial interface (Multi-master type)

Consists of a single built-in circuit with two I/O channels. The two data lines and two clock lines can be connected internally.

- Synchronous 8-bit serial interface

### (9) PWM output

- 3 channels × 7-bit PWM

#### (10) Timer

- Timer 0: 16-bit timer/counter

With 2-bit prescaler + 8-bit programmable prescaler

Mode 0: Two 8-bit timers with a programmable prescaler

Mode 1:8-bit timer with a programmable prescaler + 8-bit counter

Mode 2: 16-bit timer with a programmable prescaler

Mode 3: 16-bit counter

The resolution of timer is 1 tCYC.

- Timer 1: 16-bit timer/PWM

Mode 0: Two 8-bit timers

Mode 1:8-bit timer + 8-bit PWM

Mode 2: 16-bit timer

Mode 3: Variable bit PWM (9 to 16 bits)

In mode0/1,the resolution of Timer1/PWM is 1 tCYC

In mode2/3,the resolution is selectable by program; tCYC or 1/2 tCYC

- Base timer

Generate every 500ms overflow for a clock application (using 32.768kHz crystal oscillation for the base timer clock) Generate every 976μs, 3.9ms, 15.6ms, 62.5ms overflow (using 32.768kHz crystal oscillation for the base timer clock)

Clock for the base timer is selectable from 32.768kHz crystal oscillation, system clock or programmable prescaler output of Timer 0

### (11) Remote control receiver circuit (connected to the P73/INT3/T0IN terminal)

- Noise rejection function
- Polarity switching

### (12) Watchdog timer

External RC circuit is required

Interrupt or system reset is activated when the timer overflows

#### (13) ROM correction function

Max 128 bytes / 2 addresses

## (14) Interrupts

- 16 sources 10 vectored interrupts
  - 1. External Interrupt INTO
  - 2. External Interrupt INT1
  - 3. External Interrupt INT2, Timer/counter T0L (Lower 8 bits)
  - 4. External Interrupt INT3, base timer
  - 5. Timer/counter T0H (Upper 8 bits)
  - 6. Timer T1H,T1L
  - 7. SIO0
  - 8. Data slicer
  - 9. Vertical synchronous signal interrupt ( $\overline{VS}$ ), horizontal line ( $\overline{HS}$ ), AD
  - 10. IIC, Port 0

### - Interrupt priority control

Three interrupt priorities are supported (low, high and highest) and multi-level nesting is possible. Low or high priority can be assigned to the interrupts from 3 to 10 listed above. For the external interrupt INTO and INT1, high or highest priority can be set.

#### (15) Sub-routine stack level

- A maximum of 128 levels (stack is built in the internal RAM)

### (16) Multiplication/division instruction

- 16 bits × 8 bits (7 instruction cycle times)
- 16 bits / 8 bits (7 instruction cycle times)

### (17) 3 oscillation circuits

- Built-in RC oscillation circuit used for the system clock
- Built-in VCO circuit used for the system clock and OSD
- X'tal oscillation circuit used for base timer, system clock and PLL reference

### (18) Standby function

- HALT mode

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped. This mode can be released by the interrupt request or the system reset.

- HOLD mode

The HOLD mode is used to stop the oscillations; RC (internal), VCO, and X'tal oscillations. This mode can be released by the following conditions.

- Pull the reset terminal ( $\overline{RES}$ ) to low level.
- Feed the selected level to either P70/INT0 or P71/INT1.
- Input the interrupt condition to Port 0.

#### (19) Package

- DIP42S
- QIP48E

### (20) Development tools

- Flash EEPROM: 2 Flash microcontrollers are available:LC86F3264A,LC86F3248A. Flash version is different

depending on which microcontroller is used.

 $LC86F3264A \; (LC863264A \; / \; LC863256A) \quad \; (under \; development)$ 

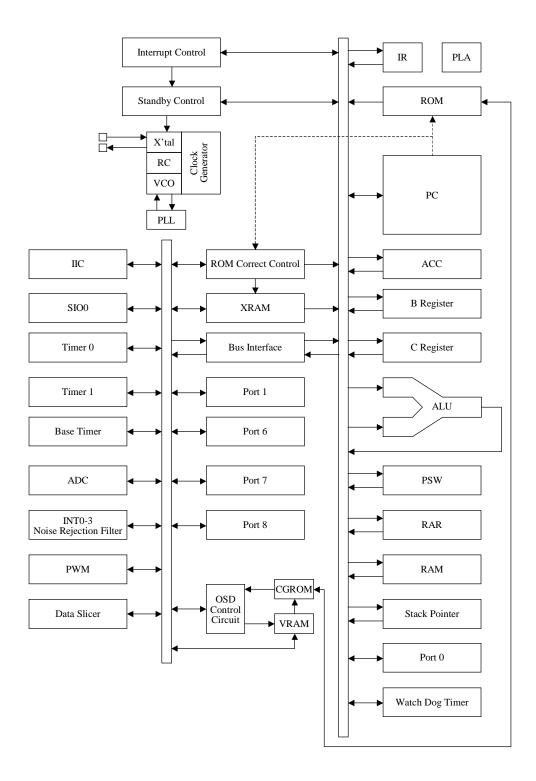
LC86F3248A (LC863248A / LC863240A)

- Evaluation chip: LC863096

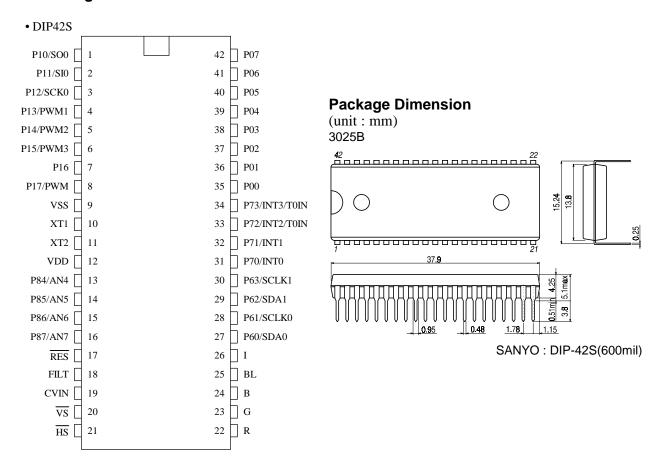
- Emulator: EVA86000 (main) + ECB863200 (evaluation chip board)

+ POD863200 (pod: DIP42S) or POD863201 (QIP48E)

## **System Block Diagram**



## **Pin Assignment**



#### • QIP48E P12/SCK0 P13/PWM1 P11/SI0 **Package Dimension** (unit: mm) 3156 P15/PWM3 36 P02 P16 35 P01 P17/PWM 34 P00 VSS 33 NC XT1 32 P73/INT3/T0IN XT2 31 P72/INT2/T0IN VDD 30 P71/INT1 NC P70/INT0 8888888888888 29 P84/AN4 P63/SCLK1 28 P85/AN5 27 P62/SDA1 P86/AN6 P61/SCLK0 26 P87/AN7 P60/SDA0 SANYO: QIP-48E NC VS HIS

## **Pin Description**

Pin Description Table

Terminal	I/O	Function Description	Option
VSS	-	Negative power supply	
XT1	I	Input terminal for crystal oscillator	
XT2	О	Output terminal for crystal oscillator	
VDD	-	Positive power supply	
RES	I	Reset terminal	
FILT	0	Filter terminal for PLL	
CVIN	I	Video signal input terminal	
VS	I	Vertical synchronization signal input terminal	
HS	I	Horizontal synchronization signal input terminal	
R	0	Red (R) output terminal of RGB image output	
G	0	Green (G) output terminal of RGB image output	
В	О	Blue (B) output terminal of RGB image output	
I	О	Intensity ( I ) output terminal of RGB image output	
BL	О	Fast blanking control signal	
		Switch TV image signal and caption/OSD image signal	
Port 0		•8-bit input/output port,	Pull-up resistor
P00 - P07	I/O	Input/output can be specified in nibble unit	provided/not provided
		•Other functions	Output Format
		HOLD release input	CMOS/Nch-OD
		Interrupt input	
Port 1		•8-bit input/output port	Output Format
P10 - P17	I/O	Input/output can be specified in a bit	CMOS/Nch-OD
		•Other functions	
		P10 SIO0 data output	
		P11 SIO0 data input/bus input/output	
		P12 SIO0 clock input/output	
		P13 PWM1 output	
		P14 PWM2 output	
		P15 PWM3 output	
		P17 Timer1 (PWM) output	
Port 6		•4-bit input/output port	
P60 - P63	I/O	Input/output can be specified for each bit	
		•Other functions	
		P60 IIC0 data I/O	
		P61 IIC0 clock output	
		P62 IIC1 data I/O	
		P63 IIC1 clock output	
		103   HC1 Clock output	

Terminal	I/O			Functi	on Descri	ption			Option
Port 7		•4-bit ir	nput/ou	tput port					
P70	I/O	Input or	output	t can be speci					
P71 - P73		•Other f	function	n					
		P	70 I	NT0 input/H0	OLD relea	se input/			
			N	Nch-Tr. outpu	t for wach	dog timer	•		
		P	71 I	NT1 input/H0	OLD relea	se input			
		P	72 I	NT2 input/Ti	mer 0 eve	nt input			
		P	73 II	NT3 input (noi	se rejection	filter conr	nected)/		
		<u> </u>		Timer 0 event					
		Interrup	t receiv	ver format, ve	ctor addre	esses			_
			risin	ng falling	rising/	H level	L level	vector	
					falling				
		INT0	enab	le enable	disable	enable	enable	03H	
		INT1	enab	le enable	disable	enable	enable	0BH	
		INT2	enab	le enable	enable	disable	disable	13H	
		INT3	enab	le enable	enable	disable	disable	1BH	
Port 8		•4-bit in	nput/ou	tput port					
P84 - P87	I/O	Input or	output	t can be speci	fied for ea	ch bit			
		•Other f	Other function						
		AD con	verter i	input port (4 l					
NC	-	Unused	termin	al					
		Leave o	pen						

- Output form and existance of pull-up resistor for all ports can be specified for each bit.
- Programmable pull-up resistor is always connected regardless of port option, CMOS or N-ch open drain output in port 1.
- Port status in reset

Terminal	I/O	Pull-up resistor status at selecting pull-up option
Port 0 I Pull-up resistor OFF, ON after reset release		Pull-up resistor OFF, ON after reset release
Port 1 I Programmable pull-up resistor OFF		Programmable pull-up resistor OFF

## 1. Absolute Maximum Ratings at VSS=0V and Ta=25°C

D.		G 1 1	D,	G I'v'			Ratings		٠,
Para	meter	Symbol	Pins	Conditions	VDD[V]	min.	typ.	max.	unit
Supply v	oltage	VDDMAX	VDD			-0.3		+7.0	V
Input vol	ltage	VI(1)	• RES , HS , VS , CVIN			-0.3		VDD+0.3	
Output v	oltage	VO(1)	R, G, B, I, BL, FILT			-0.3		VDD+0.3	
Input/ou			•Ports 0, 1, 6, 7,			-0.3		VDD+0.3	
High level	Peak output	IOPH(1)	•Ports 0, 1, 7, 8	•CMOS output •For each pin.		-4			mA
output current	current	IOPH(2)	R, G, B, I, BL	•CMOS output •For each pin.		-5			
	Total	$\Sigma$ IOAH(1)	•Ports 0, 1	Total of all pins.		-20			
	output	∑IOAH(2)	Ports 7, 8	Total of all pins.		-10			
	current	∑IOAH(3)	R, G, B, I, BL	Total of all pins.		-15			
Low	Peak	IOPL(1)	Ports 0, 1, 6, 8	For each pin.				20	
level	output	IOPL(2)	Port 7	For each pin.				15	
output	current	IOPL(3)	R, G, B, I, BL	For each pin.				5	
current	Total	ΣIOAL(1)	Ports 0, 1	Total of all pins.				40	
	output	ΣIOAL(2)	Ports 6, 7, 8	Total of all pins.				40	
	current	ΣIOAL(3)	R, G, B, I, BL	Total of all pins.				15	
Maximu	m power	Pdmax	DIP42S	Ta=-10 to +70°C				800	mW
dissipatio	on		QIP48E					400	
Operatin	g	Topr				-10		+70	°C
temperat range	_								
Storage temperat range	ure	Tstg				-55		+125	

## 2. Recommended Operating Range at Ta=-10°C to +70°C, VSS=0V

Parameter	Symbol	Pins	Conditions			Ratings		unit
- Turumeter	Bymoor	Tins	Conditions	VDD[V]	min.	typ.	max.	umi
Operating supply voltage	VDD(1)	VDD	0.844μs ≤ tCYC ≤ 0.852μs		4.5		5.5	V
range	VDD(2)		4μs ≤ tCYC ≤ 400μs		4.5		5.5	
Hold voltage	VHD	VDD	RAMs and the registers data are kept in HOLD mode.		2.0		5.5	
High level input voltage	VIH(1)	Port 0 (Schumitt)	Output disable	4.5 - 5.5	0.6VDD		VDD	
	VIH(2)	•Ports 1,6 (Schumitt) •Port 7 (Schumitt) port input/interrupt • HS, VS, RES (Schumitt)	Output disable	4.5 - 5.5	0.75VDD		VDD	
	VIH(3)	Port 70 Watchdog timer input	Output disable	4.5 - 5.5	VDD-0.5		VDD	
	VIH(4)	•Port 8 port input	Output disable	4.5 - 5.5	0.7VDD		VDD	
Low level	VIL(1)	Port 0 (Schumitt)	Output disable	4.5 - 5.5	VSS		0.2VDD	
input voltage	VIL(2)	•Ports 1,6 (Schumitt) •Port 7 (Schumitt) port input/interrupt • HS, VS, RES (Schumitt)	Output disable	4.5 - 5.5	VSS		0.25VDD	
	VIL(3)	Port 70 Watchdog timer input	Output disable	4.5 - 5.5	VSS		0.6VDD	
	VIL(4)	Port 8 port input	Output disable	4.5 - 5.5	VSS		0.3VDD	
CVIN	VCVIN	CVIN		5.0	1Vp-p -3dB	1Vp-p	1Vp-p +3dB	Vp-p
Operation cycle time	tCYC(1)		•All functions operating	4.5 - 5.5	0.844	0.848	0.852	μs
	tCYC(2)		•AD converter operating •OSD and Data slicer are not operating	4.5 - 5.5	0.844		30	
	tCYC(3)		•OSD, AD converter and Data slicer are not operating	4.5 - 5.5	0.844		400	
Oscillation frequency range	FmRC		Internal RC oscillation	4.5 - 5.5	0.4	0.8	3.0	MHz

<sup>\*</sup> Vp-p : Peak-to-peak voltage

## 3. Electrical Characteristics at Ta=-10°C to +70°C, VSS=0V

Parameter	Symbol	Pins	Conditions			Ratings		unit
T urumeter	Бушоог	1 1115	Conditions	VDD[V]	min.	typ.	max.	um
High level input current	IIH(1)	Ports 0, 1, 6, 7, 8	•Output disable •Pull-up MOS Tr. OFF •VIN=VDD	4.5 - 5.5			1	μА
			(including the off- leak current of the output Tr.)					
	IIH(2)	• RES • HS , VS	•VIN=VDD	4.5 - 5.5			1	
Low level input current	IIL(1)	Ports 0, 1, 6, 7, 8	•Output disable •Pull-up MOS  Tr. OFF •VIN=VSS  (including the off-leak current of the output Tr.)	4.5 - 5.5	-1			
	IIL(2)	• RES • HS , VS	VIN=VSS	4.5 - 5.5	-1			
High level output voltage	VOH(1)	•CMOS output of ports 0,1,71-73,8	IOH=-1.0mA	4.5 - 5.5	VDD-1			V
	VOH(2)	R, G, B, I, BL	IOH=-0.1mA	4.5 - 5.5	VDD-0.5			ļ
Low level	VOL(1)	Ports 0,1,71-73,8	IOL=10mA	4.5 - 5.5			1.5	
output voltage	VOL(2)	Ports 0,1,71-73,8	IOL=1.6mA	4.5 - 5.5			0.4	
	VOL(3)	•R, G, B, I, BL •Port 6	IOL=3.0mA	4.5 - 5.5			0.4	
	VOL(4)	Port 6	IOL=6.0mA	4.5 - 5.5			0.6	
	VOL(5)	Port 70	IOL=1mA	4.5 - 5.5			0.4	
Pull-up MOS Tr. resistance	Rpu	•Ports 0, 1, 7, 8	VOH=0.9VDD	4.5 - 5.5	13	38	80	ΚΩ
Bus terminal short circuit resistance (SCL0-SCL1, SDA0-SDA1)	RBS	•P60-P62 •P61-P63		4.5 - 5.5			130	Ω
Hysteresis voltage	VHIS	•Ports 0, 1, 6, 7 • RES • HS, VS	Output disable	4.5 - 5.5		0.1VDD		V
Input clump votage	VCLMP	CVIN		5.0	2.3	2.5	2.7	
Pin capacitance	СР	All pins	•f=1MHz •Every other terminals are connected to VSS. •Ta=25°C	4.5 - 5.5		10		pF

## 4. Serial Input/Output Characteristics at Ta=-10°C to +70°C, VSS=0V

		D .	G 1 1	D.	C I''			Ratings		٠,
		Parameter	Symbol	Pins	Conditions	VDD[V]	min.	typ.	max.	unit
	:k	Cycle	tCKCY(1)	•SCK0 •SCLK0	Refer to figure 4.	4.5 - 5.5	2			tCYC
	Input clock	Low Level pulse width	tCKL(1)				1			
clock	lul	High Level pulse width	tCKH(1)				1			
Serial clock	ck	Cycle	tCKCY(2)	•SCK0 •SCLK0	•Use pull-up resistor (1kΩ)	4.5 - 5.5	2			
	Output clock	Low Level pulse width	tCKL(2)		when Nch open- drain output.			1/2tCKCY		
	Ou	High Level pulse width	tCKH(2)		•Refer to figure 4.			1/2tCKCY		
Serial input	Da	ata set up time	tICK	SI0	•Data set-up to SCK0. •Data hold from	4.5 - 5.5	0.1			μs
Serial	Da	ata hold time	tCKI		SCK0. •Refer to figure 4.		0.1			
utput		utput delay time Ising external	tCKO(1)	SO0	•Data hold from SCK0. •Use pull-up	4.5 - 5.5			7/12tCYC +0.2	
Serial output		utput delay time (sing internal clock)	tCKO(2)	SO0	resistor (1kΩ) when Nch opendrain output. •Refer to figure 4.	4.5 - 5.5			1/3tCYC +0.2	

## 5. IIC Input/Output Conditions at Ta=-10°C to +70°C, VSS=0V

Donometer	Camab al	Stan	ıdard	High	speed	:4
Parameter	Symbol	min.	max.	min.	max.	unit
SCL Frequency	fSCL	0	100	0	400	kHz
BUS free time between stop - start	tBUF	4.7	-	1.3	1	μs
HOLD time of start, restart condition	tHD;STA	4.0	-	0.6	1	μs
L time of SCL	tLOW	4.7	-	1.3	1	μs
H time of SCL	tHIGH	4.0	-	0.6	-	μs
Set-up time of restart condition	tSU;STA	4.7	-	0.6	-	μs
HOLD time of SDA	tHD;DAT	0	-	0	0.9	μs
Set-up time of SDA	tSU;DAT	250	-	100	-	ns
Rising time of SDA, SCL	tR	-	1000	20+0.1Cb	300	ns
Falling time of SDA, SCL	tF	-	300	20+0.1Cb	300	ns
Set-up time of stop condition	tSU;STO	4.0	-	0.6	-	μs

Refer to figure 10

(Note) Cb: Total capacitance of all BUS (unit: pF)

## 6. Pulse Input Conditions at Ta=-10°C to +70°C, VSS=0V

ъ.	G 1 1	D.	G Tivi			Ratings		.,
Parameter	Symbol	Pins	Conditions	VDD[V]	min.	typ.	max.	unit
High/low level pulse width	tPIH(1) tPIL(1)	•INT0, INT1 •INT2/T0IN	•Interrupt acceptable •Timer0-countable	4.5 - 5.5	1			tCYC
	tPIH(2) tPIL(2)	INT3/T0IN (1/1 is selected for noise rejection clock.)	•Interrupt acceptable •Timer0-countable	4.5 - 5.5	2			
	tPIH(3) tPIL(3)	INT3/T0IN (1/16 is selected for noise rejection clock.)	•Interrupt acceptable •Timer0-countable	4.5 - 5.5	32			
	tPIH(4) tPIL(4)	INT3/T0IN (1/64 is selected for noise rejection clock.)	•Interrupt acceptable •Timer0-countable	4.5 - 5.5	128			
	tPIL(5)	RES	Reset acceptable	4.5 - 5.5	200			μs
	tPIH(6) tPIL(6)	HS, VS	Display position controllable (Note)     The active edge of HS and VS must be apart at least 1 tCYC.     Refer to figure 6.	4.5 - 5.5	8			
Rising/falling time	tTHL tTLH	HS	Refer to figure 6.	4.5 - 5.5			500	ns

## 7. AD Converter Characteristics at Ta=-10°C to + 70°C, VSS=0V

D	C11	Dia.	Con this are			Ratings		
Parameter	Symbol	Pins	Conditions	VDD[V]	min.	typ.	max.	unit
Resolution	N			4.5 – 5.5		8		bit
Absolute	ET		(Note 3)				±1.5	LSB
precision								
Conversion	tCAD		ADCR2=0 (Note 4)			16		tCYC
time			ADCR2=1 (Note 4)			32		
Analog input	VAIN	AN4 - AN7			VSS		VDD	V
voltage range								
Analog port	IAINH		VAIN=VDD				1	μΑ
input current	IAINL		VAIN=VSS		-1			

(Note 3) Absolute precision does not include quantizing error (1/2LSB).

(Note 4) Conversion time is the time till the complete digital conversion value for analog input value is set to a register after the instruction to start conversion is sent.

## 8. Sample Current Dissipation Characteristics at Ta=-10°C to +70°C, VSS=0V

The sample current dissipation characteristics is the measurement result of Sanyo provided evaluation board when the recommended circuit parameters shown in the sample oscillation circuit characteristics are used externally. The currents through the output transistors and the pull-up MOS transistors are ignored.

Parameter	Symbol	Pins	Conditions			Ratings		unit
r at attletet	Symbol	FIIIS	Conditions	VDD[V]	min.	typ.	max.	uiiit
Current dissipation during basic operation (Note 3)	IDDOP(1)	VDD	•FmX'tal=32.768kHz X'tal oscillation •System clock: VCO •VCO for OSD operating •Internal RC oscillation stops	4.5 - 5.5		19	32	mA
Current dissipation in HALT mode (Note 3)	IDDHALT(1)	VDD	•HALT mode •FmX'tal=32.768kHz X'tal oscillation •System clock: VCO •VCO for OSD stops •Internal RC oscillation stops	4.5 - 5.5		7	12	mA
	IDDHALT(2)	VDD	•HALT mode •FmX'tal=32.768kHz X'tal oscillation •VCO for system stops •VCO for OSD stops •System clock: Internal RC	4.5 - 5.5		300	1200	μА
	IDDHALT(3)	VDD	•HALT mode •FmX'tal=32.768kHz X'tal oscillation •VCO for system stops •VCO for OSD stops •System clock: X'tal	4.5 - 5.5		50	200	
Current dissipation in HOLD mode (Note 3)	IDDHOLD	VDD	•HOLD mode •All oscillation stops.	4.5 - 5.5		0.05	20	μΑ

(Note 3) The currents through the output transistors and the pull-up MOS transistors are ignored.

#### Recommended Oscillation Circuit and Sample Characteristics

The sample oscillation circuit characteristics in the table below is based on the following conditions:

- Recommended circuit parameters are verified by an oscillator manufacturer using a Sanyo provided oscillation evaluation board.
- Sample characteristics are the result of the evaluation with the recommended circuit parameters connected externally.

Recommended oscillation circuit and sample characteristics ( $Ta = -10 \text{ to } +70^{\circ}\text{C}$ )

Frequency	Manufacturer	Oscillator	Recommended circuit parameters				Operating supply voltage	Oscillation stabilizing time		Notes
			C1	C2	Rf	Rd	range	typ.	max	
32.768kHz	Seiko Epson	C-002RX	18pF	18pF	Open	390kΩ	4.5 – 5.5V	1.00s	1.50s	

Notes

The oscillation stabilizing time period is the time until the VCO oscillation for the internal system becomes stable after the following conditions. (Refer to Figure 2.)

- 1. The VDD becomes higher than the minimum operating voltage after the power is supplied.
- 2. The HOLD mode is released.

The sample oscillation circuit characteristics may differ applications. For further assistance, please contact with oscillator manufacturer with the following notes in your mind.

- Since the oscillation frequency precision is affected by wiring capacity of the application board, etc., adjust the
  oscillation frequency on the production board.
- The above oscillation frequency and the operating supply voltage range are based on the operating temperature of -10°C to +70°C. For the use with the temperature outside of the range herein, or in the applications requiring high reliability such as car products, please consult with oscillator manufacturer.
- When using the oscillator which is not shown in the sample oscillation circuit characteristics, please consult with Sanyo sales personnel.

Since the oscillation circuit characteristics are affected by the noise or wiring capacity because the circuit is designed with low gain in order to reduce the power dissipation, refer to the following notices.

- The distance between the clock I/O terminal (XT1 terminal XT2 terminal) and external parts should be as short as possible.
- The capacitors' VSS should be allocated close to the microcontroller's GND terminal and be away from other GND.
- The signal lines with rapid state changes or with large current should be allocated away from the oscillation circuit.

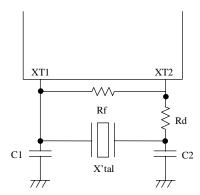


Figure 1 Recommended oscillation circuit.

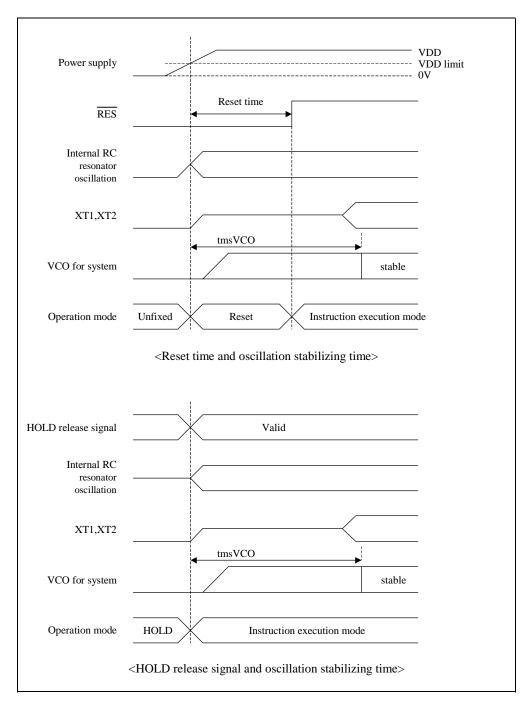
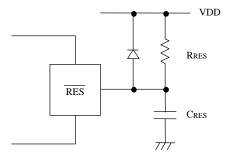
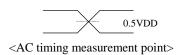


Figure 2 Oscillation stabilizing time



(Note) Determine the CRES, RRES value to generate more than 200µs reset time.

Figure 3 Reset circuit



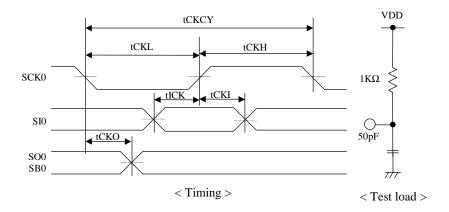


Figure 4 Serial input / output test condition

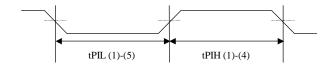


Figure 5 Pulse input timing condition – 1

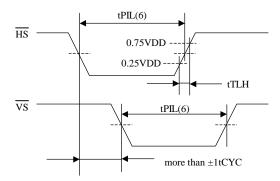


Figure 6 Pulse input timing condition - 2

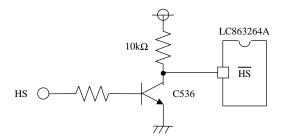
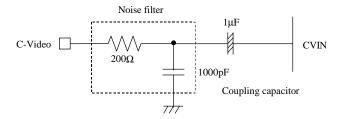


Figure 7 Recommended Interface circuit



Output impedance of C-Video before Noise filter should be less then  $100\Omega$ .

Figure 8 CVIN recommended circuit

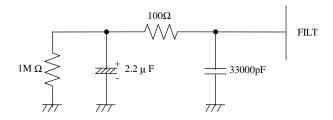
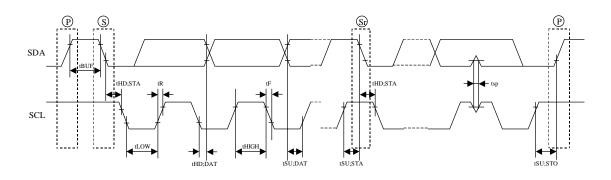


Figure 9 FILT recommended circuit

(Note) Place FILT parts on board as close to the microcontroller as possible.



S : start condition
P : stop condition
Sr : restart condition

tsp: Spike suppression

Standard mode : not exist High speed mode : less than 50ns

Figure 10 IIC timing

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